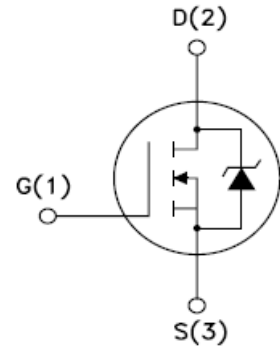
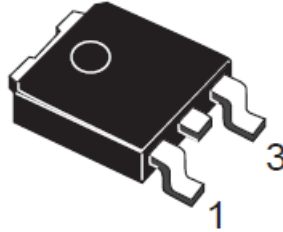


# LTspice Model

## NMOS

## STM

## STD35NF06L



### Model Information

**Model** A macro model based on BSIM3 model  
**Call Name** MDC\_STD35NF06L\_LT  
**Pin Assign** 1:G 2:D 3:S  
**File List** Model Library MDC\_STD35NF06L\_LT01.lib  
 Model Report MDC\_STD35NF06L\_LT.pdf (this file)

**Verified Simulator Version** LTspice version XVII  
**Note**

### References

The information which was used for modeling is as follow:

[Data Sheet]

- Date/Version November 2003
- Product name STD35NF06L
- Company name STMicroelectronics N.V.
- Characteristics IdVds[Vgs], IdVgs[Temp], YfsId[Temp], Rds(on)Id[Vgs], VgsQg[Vdd], CapacitanceVds[Cname], NormVthTemp[Id], NormRds(o n)Temp[Vgs], Vsds[Temp], SwitchingIdd[Tname], Trrff[Ir], Qrrlf [Ir], SwitchingWaveform, TrrWaveform

### Simulation Range

This table shows the range of evaluated simulation range that was not occurs any convergence problems in this area.

Item	Range			Unit
	Min.		Max.	
Drain-source voltage (DC)	0	to	60	V
Gate-source voltage (DC)	-16	to	16	V
Temperature	-55	to	175	deg C

## MOSFET

○ : Implemented  
× : Not Implemented  
— : Not applicable

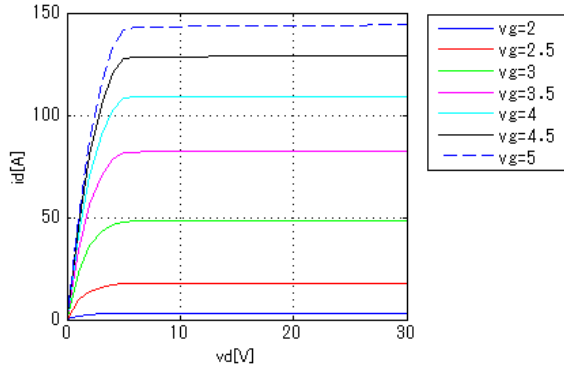
**Model Functions Table**
**RANK=1**

Functions	RANK	Implemented
ID-VDS-VGS	1	○
ID-VGS(Temp)	1	○
RDS(on)	1	○
Capacitance	1	○
Gate Charge	1	○
IS-VSD(Forward)	1	○
Reverse recovery	1	○
Switching(Typ.)	1	○
Bv	1	—
Yfs	1	○
Vth	1	○

Simulation results are following.  
 Explanatory notes — : simulated

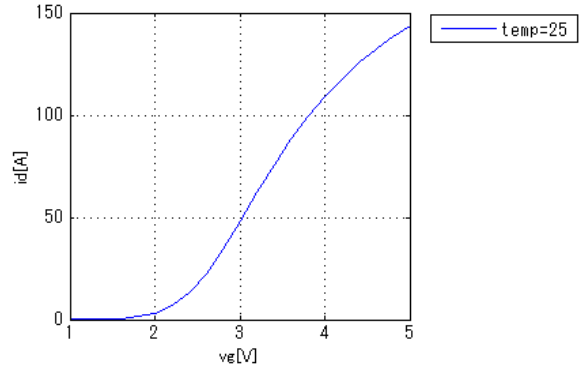
**IdVds[Vgs]**

Temp = 25degC



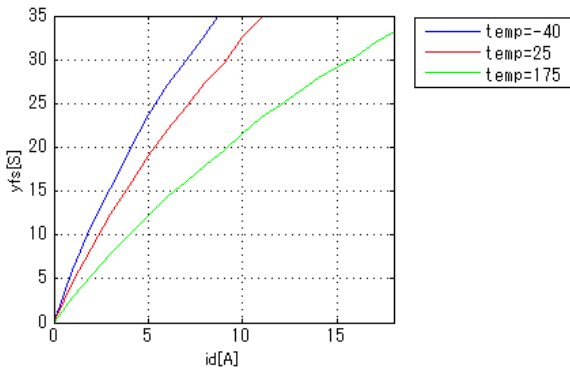
**IdVgs[Temp]**

Vds = 25V



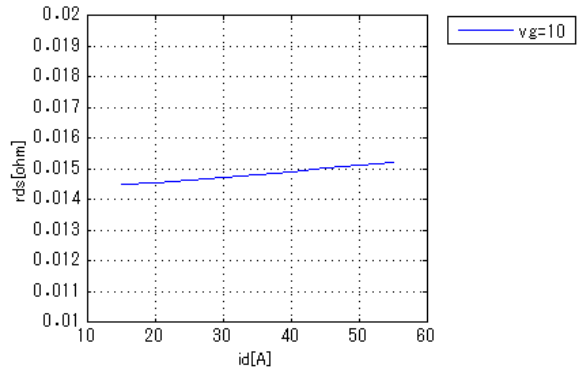
**YfsId[Temp]**

Vds = 15V



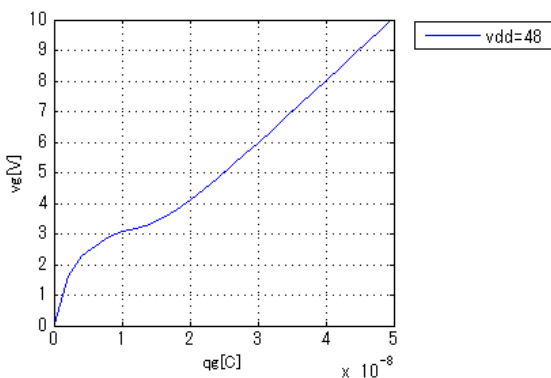
**Rds(on)Id[Vgs]**

Temp = 25degC



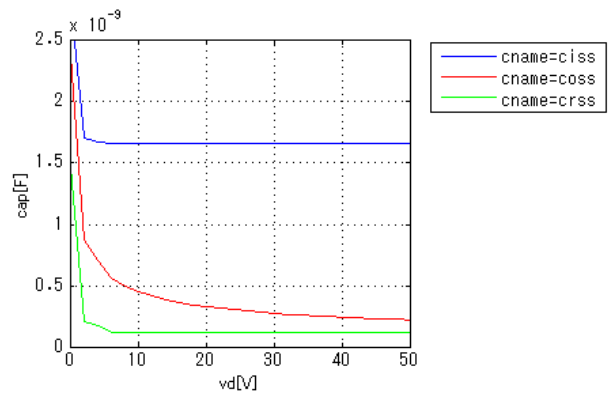
**VgsQg[Vdd]**

Id = 55A



**CapacitanceVds[Cname]**

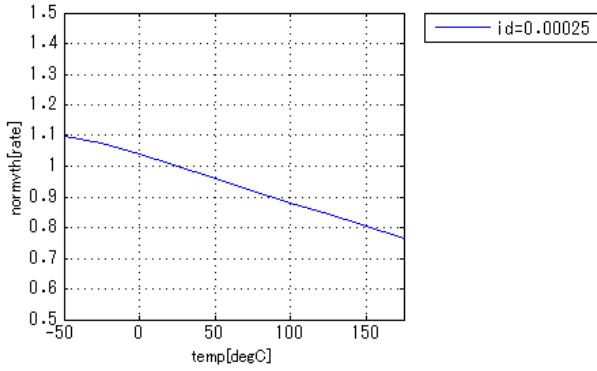
freq = 1000000Hz



Simulation results are following.  
 Explanatory notes — : simulated

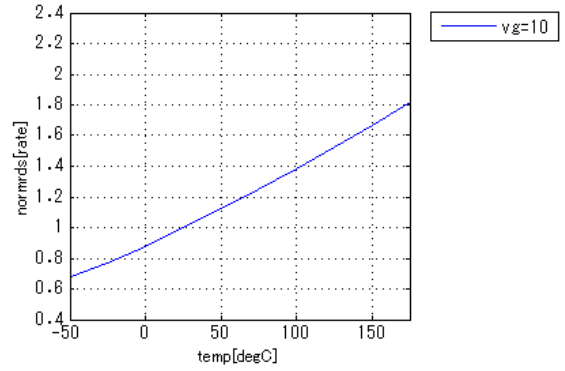
**NormVthTemp[Id]**

Vd = Vg



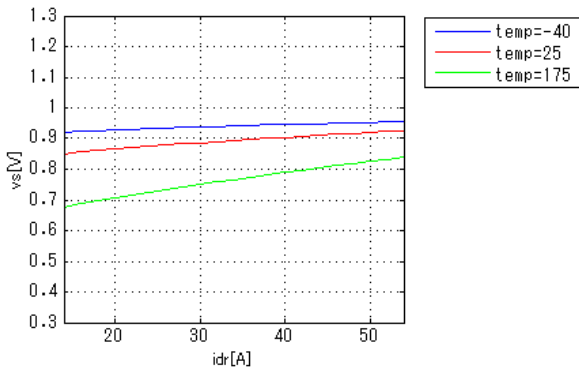
**NormRds(on)Temp[Vgs]**

Id = 27.5A



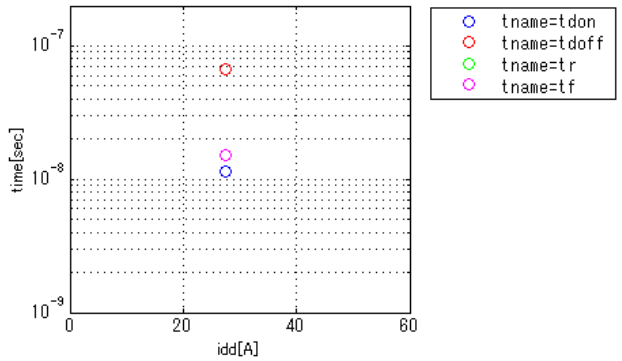
**VsdlS[Temp]**

vg = 0V



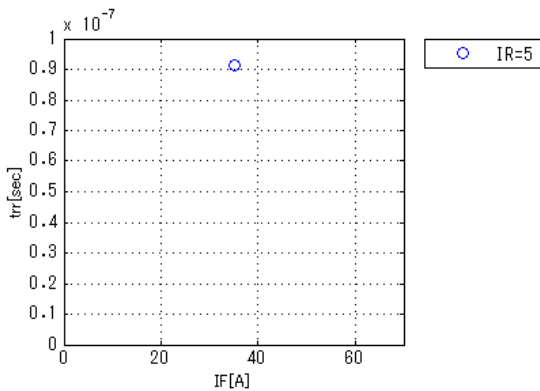
**SwitchingIdd[Tname]**

vgg = 4.5V, vdd = 30V, RGG = 4.7ohm



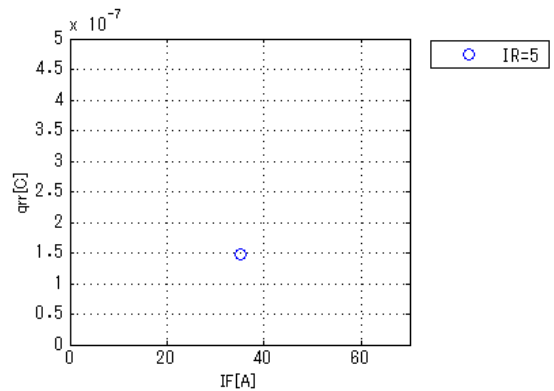
**Trrlf[Ir]**

vdd = 30V, didt = 100A/us, Temp = 150degC



**Qrrlf[Ir]**

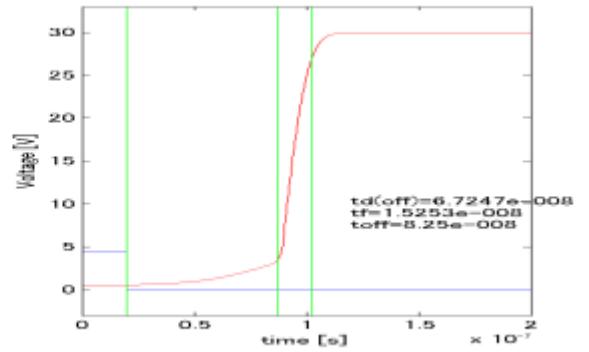
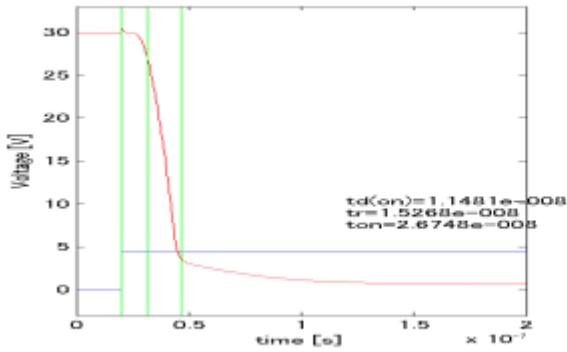
vdd = 30V, didt = 100A/us, Temp = 150degC



Simulation results are following.  
 Explanatory notes — : simulated

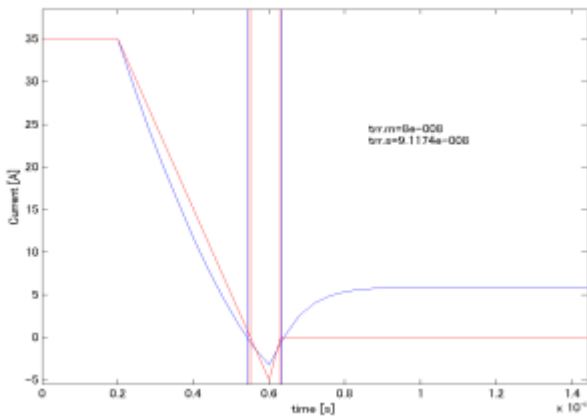
**Switching Waveform ( Blue : INPUT Red : OUTPUT )**

vgg = 4.5V, vdd = 30V, RGG = 4.7ohm, idd = 27.5A



**Trr Waveform ( Red : DATASHEET Blue : SIMULATION )**

vdd = 30V, didt = 100A/us, Temp = 150degC, IF = 35A, IR = 5A



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